Supertex inc.

VP0350



P-Channel Enhancement-Mode Vertical DMOS FETs

Ordering Information

Γ	BV _{DSS} /	R _{DS(ON)} (max)	I _{D(ON)} (min)	Order Number / Package				
	BV _{DGS}			TO-3	TO-220	Die [†]		
Г	-500V	7.5Ω	-1A	VP0350N1	VP0350N5	VP0350ND		

[†] MIL visual screening available

High Reliability Devices

See pages 5-4 and 5-5 for MILITARY STANDARD Process Flows and Ordering Information.

Features

- ☐ Free from secondary breakdown
- Low power drive requirement
- □ Ease of paralleling
- ☐ Low C_{iss} and fast switching speeds
- Excellent thermal stability
- □ Integral Source-Drain diode
- High input impedance and high gain
- Complementary N- and P-channel devices

Applications

- Motor controls
- Converters
- Amplifiers
- Switches
- Power supply circuits
- Drivers (relays, hammers, solenoids, lamps, memories, displays, bipolar transistors, etc.)

Absolute Maximum Ratings

Drain-to-Source Voltage	BV_{DSS}
Drain-to-Gate Voltage	BV_{DGS}
Gate-to-Source Voltage	± 20V
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

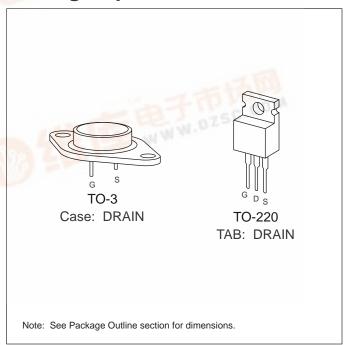
Distance of 1.6 mm from case for 10 seconds.

Advanced DMOS Technology

These enhancement-mode (normally-off) transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Package Options



Thermal Characteristics

Package	I _D (continuous)*	I _D (pulsed)	Power Dissipation @ T _C = 25°C	θ _{jc} °C/W	θ _{ja} °C/W	I _{DR} *	I _{DRM}
TO-3	-1.5A	-3.0A	100W	1.25	30	-1.5A	-3.0A
TO-220	-1.0A	-3.0A	50W	2.5	40	-1.0A	-3.0A

^{*} I_D (continuous) is limited by max rated T_{i} .

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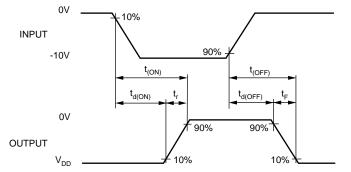
Electrical Characteristics (@ 25°C unless otherwise specified)

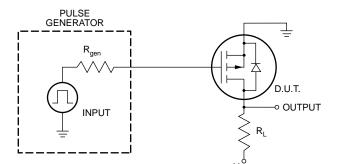
Symbol	Parameter	Min	Тур	Max	Unit	Conditions	
BV _{DSS}	Drain-to-Source Breakdown Voltage	-500			V	V _{GS} = 0V, I _D =-10mA	
V _{GS(th)}	Gate Threshold Voltage	-2.5		-4.5	V	$V_{GS} = V_{DS}$, $I_D = -10$ mA	
$\Delta V_{GS(th)}$	Change in V _{GS(th)} with Temperature		4.8	6.0	mV/°C	$V_{GS} = V_{DS}$, $I_D = -10$ mA	
I _{GSS}	Gate Body Leakage			-100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
I _{DSS}	Zero Gate Voltage Drain Current			-200	μΑ	$V_{GS} = 0V$, $V_{DS} = Max$ Rating	
				-2	mA	$V_{GS} = 0V$, $V_{DS} = 0.8$ Max Rating $T_A = 125$ °C	
I _{D(ON)}	ON-State Drain Current		-1.5		А	$V_{GS} = -5V, V_{DS} = -25V$	
			-3.0			$V_{GS} = -10V, V_{DS} = -25V$	
R _{DS(ON)}	Static Drain-to-Source		6.0		Ω	$V_{GS} = -5V, I_D = -0.25A$	
	ON-State Resistance		5.5	7.5		$V_{GS} = -10V, I_D = -0.25A$	
$\Delta R_{DS(ON)}$	Change in R _{DS(ON)} with Temperature		0.7	1.2	%/°C	$V_{GS} = -10V, I_D = -0.25A$	
G _{FS}	Forward Transconductance	0.25	0.45		$^{\circ}$	$V_{DS} = -25V, I_{D} = -0.5A$	
C _{ISS}	Input Capacitance		720	800		V 0V V 05V	
C _{OSS}	Common Source Output Capacitance		110	130	pF	$V_{GS} = 0V, V_{DS} = -25V$ f = 1 MHz	
C _{RSS}	Reverse Transfer Capacitance		20	50	-		
t _{d(ON)}	Turn-ON Delay Time		11	30			
t _r	Rise Time Turn-OFF Delay Time		11	30	ns	$V_{DD} = -25V$ $I_{D} = -1A$ $R_{GEN} = 10\Omega$	
t _{d(OFF)}			70	100			
t _f	Fall Time		22	30		GEN	
V _{SD}	Diode Forward Voltage Drop		-1.0	-1.3	V	$V_{GS} = 0V, I_{SD} = -0.25A$	
t _{rr}	Reverse Recovery Time		550		ns	$V_{GS} = 0V, I_{SD} = -0.25A$	

Notes

- 1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)
- 2. All A.C. parameters sample tested.

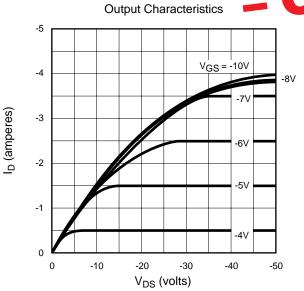
Switching Waveforms and Test Circuit

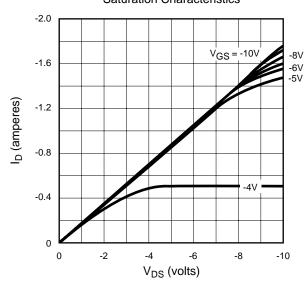


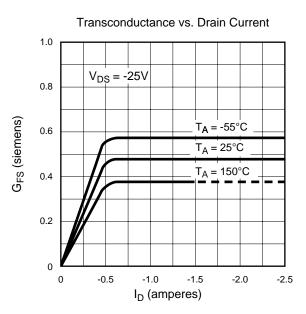


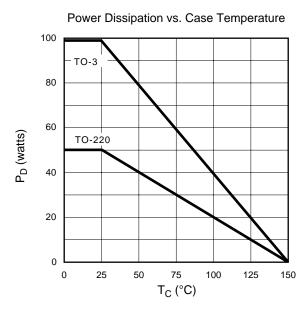
Typical Performance Curves

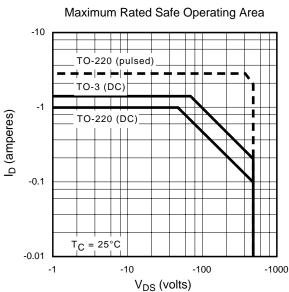
OBSOLETE Saturation Characteristics

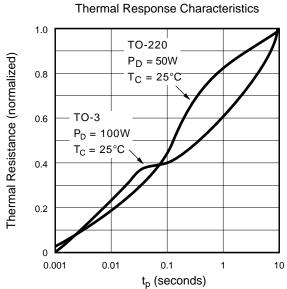






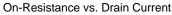


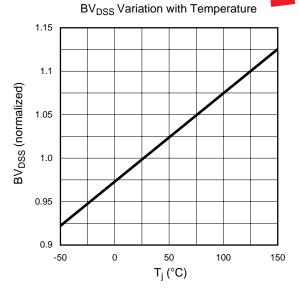


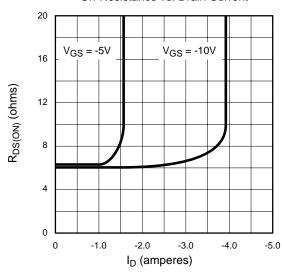


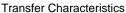
Typical Performance Curves

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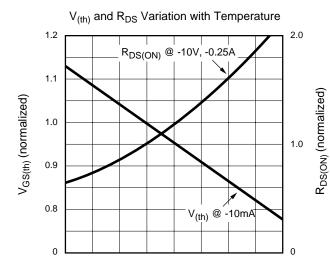


 $V_{DS} = -25V$ -4.0 I_D (amperes) -3.0 -1.0

-5.0

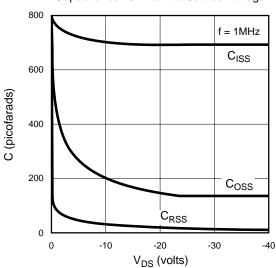
0 0

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Capacitance vs. Drain-to-Source Voltage

V_{GS} (volts)



Gate Drive Dynamic Characteristics

50

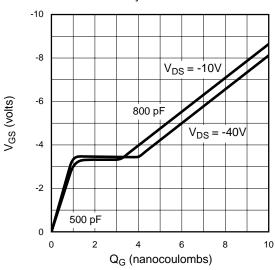
T_i (°C)

100

150

-50

0



05/19/03